Electronic Patent Application Fee Transmittal									
Application Number:	10567733								
Filing Date:	10-Feb-2006								
Title of Invention:	Method for forming film, method for manufacturing semiconductor device, semiconductor device and substrate treatment system								
First Named Inventor/Applicant Name:	Kohei Kawamura								
Filer:	Marvin Jay Spivak/Yuriko Stankich								
Attorney Docket Number:	285995US26PCT								
Filed as Large Entity									
U.S. National Stage under 35 USC 371 Filing Fees									
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Basic Filing:									
Pages:									
Claims:									
Miscellaneous-Filing:									
Petition:									
Patent-Appeals-and-Interference:									
Post-Allowance-and-Post-Issuance:									
Extension-of-Time:									
Extension - 3 months with \$0 paid		1253	1	1110	1110				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
iscellaneous:						
Request for continued examination	1801	1	810	810		
	Tot	Total in USD (\$)				